# 5-826634-0 - ACTIVE

### AMPMODU | AMPMODU Headers

TE Internal #: 5-826634-0 PCB Mount Header, Right Angle, Board-to-Board, 100 Position, 2.54 mm [.1 in] Centerline, Breakaway, AMPMODU Headers View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Right Angle

Connector System: Board-to-Board

Number of Positions: 100

Number of Rows: 2

# Features

Product Type Features

PCB Connector Assembly Type	PCB Mount Header
Connector System	Board-to-Board
Header Type	Breakaway
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Connector Contact Load Condition	Fully Loaded
PCB Mount Orientation	Right Angle
PCB Mount Orientation Number of Positions	Right Angle 100
Number of Positions	100
Number of Positions Number of Rows	100
Number of Positions Number of Rows Board-to-Board Configuration	100

PCB Mount Header, Right Angle, Board-to-Board, 100 Position, 2.54 mm [.1 in] Centerline, Breakaway, AMPMODU Headers



# **Body Features**

Primary Product Color	Green
Contact Features	
Mating Square Post Dimension	.63 mm[.025 in]
PCB Contact Termination Area Plating Material Thickness	3 µm
Contact Shape & Form	Square
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Gold or Gold Flash over Palladium Nickel
Contact Mating Area Plating Material Thickness	.8 μm[31.5 μin]
Contact Type	Pin
Contact Current Rating (Max)	5 A
Termination Features	
Square Termination Post & Tail Dimension	.63 mm[.025 in]
Termination Post & Tail Length	3.2 mm[.126 in]
Termination Method to Printed Circuit Board	Through Hole - Solder

#### Mechanical Attachment

Centerline (Pitch)2.54 mm[.1 in]Housing MaterialPBTDimensions2.54 mm[.1 in]Row-to-Row Spacing2.54 mm[.1 in]PCB Thickness (Recommended)1.57 mm[.062 in]Usage ConditionsStandardUsage ConditionsStandardOperating Temperature RatingStandardOperating Temperature Range-65 – 105 °C[-85 – 221 °F]		
PCB Mount AlignmentWithoutConnector Mounting TypeBoard MountHousing FeaturesEventoring (Pitch)Centerline (Pitch)2.54 mm[.1 in]Housing MaterialPBTDimensions2.54 mm[.1 in]Row-to-Row Spacing2.54 mm[.1 in]PCB Thickness (Recommended)1.57 mm[.062 in]Usage ConditionsStandardHousing Temperature RatingStandardOperating Temperature Range-65 – 105 °C[-85 – 221 °F]	Mating Alignment	Without
Connector Mounting TypeBoard MountHousing FeaturesSourd MountCenterline (Pitch)2.54 mm[.1 in]Housing MaterialPBTDimensions2.54 mm[.1 in]Row-to-Row Spacing2.54 mm[.1 in]PCB Thickness (Recommended)1.57 mm[.062 in]Usage Conditions1.57 mm[.062 in]Housing Temperature RatingStandardOperating Temperature Range-65 – 105 °C[-85 – 221 °F]	PCB Mount Retention	Without
Housing FeaturesCenterline (Pitch)2.54 mm[.1 in]Housing MaterialPBTDimensions2.54 mm[.1 in]Row-to-Row Spacing2.54 mm[.1 in]PCB Thickness (Recommended)1.57 mm[.062 in]Usage ConditionsUsage ConditionsHousing Temperature RatingStandardOperating Temperature Range-65 – 105 °C[-85 – 221 °F]	PCB Mount Alignment	Without
Centerline (Pitch)2.54 mm[.1 in]Housing MaterialPBTDimensions2.54 mm[.1 in]Row-to-Row Spacing2.54 mm[.1 in]PCB Thickness (Recommended)1.57 mm[.062 in]Usage ConditionsStandardUsage ConditionsStandardOperating Temperature RatingStandardOperating Temperature Range-65 – 105 °C[-85 – 221 °F]	Connector Mounting Type	Board Mount
Housing Material       PBT         Dimensions       2.54 mm[.1 in]         Row-to-Row Spacing       2.54 mm[.062 in]         PCB Thickness (Recommended)       1.57 mm[.062 in]         Usage Conditions       Standard         Housing Temperature Rating       Standard         Operating Temperature Range       -65 – 105 °C[-85 – 221 °F]	Housing Features	
Dimensions         Row-to-Row Spacing       2.54 mm[.1 in]         PCB Thickness (Recommended)       1.57 mm[.062 in]         Usage Conditions       Image: Conditions         Housing Temperature Rating       Standard         Operating Temperature Range       -65 – 105 °C[-85 – 221 °F]	Centerline (Pitch)	2.54 mm[.1 in]
Row-to-Row Spacing2.54 mm[.1 in]PCB Thickness (Recommended)1.57 mm[.062 in]Usage ConditionsHousing Temperature RatingOperating Temperature RangeStandard-65 – 105 °C[-85 – 221 °F]	Housing Material	PBT
PCB Thickness (Recommended) 1.57 mm[.062 in]   Usage Conditions Housing Temperature Rating   Operating Temperature Range -65 – 105 °C[-85 – 221 °F]	Dimensions	
Usage Conditions         Housing Temperature Rating       Standard         Operating Temperature Range       -65 – 105 °C[-85 – 221 °F]	Row-to-Row Spacing	2.54 mm[.1 in]
Housing Temperature RatingStandardOperating Temperature Range-65 - 105 °C[-85 - 221 °F]	PCB Thickness (Recommended)	1.57 mm[.062 in]
Operating Temperature Range -65 – 105 °C[-85 – 221 °F]	Usage Conditions	
	Housing Temperature Rating	Standard
Operation/Application	Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
	Operation/Application	

**C** For support call+1 800 522 6752

PCB Mount Header, Right Angle, Board-to-Board, 100 Position, 2.54 mm [.1 in] Centerline, Breakaway, AMPMODU Headers



Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	100
Packaging Type	Carton
<b>Product Compliance</b> For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Canability	Wave solder canable to 265°C

Wave solder capable to 265°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# **Compatible Parts**

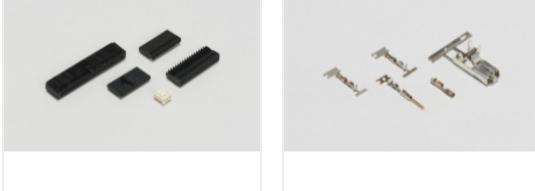
PCB Mount Header, Right Angle, Board-to-Board, 100 Position, 2.54 mm [.1 in] Centerline, Breakaway, AMPMODU Headers





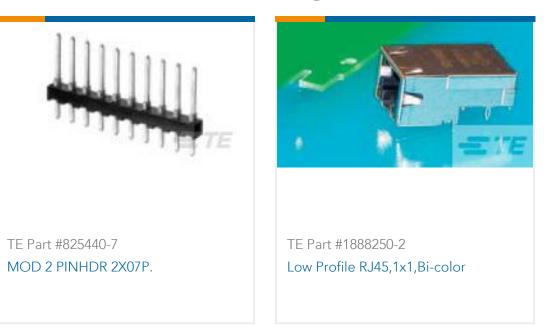
# Also in the Series AMPMODU Headers





Wire-to-Board Connector Assemblies	Wire-to-Board Connector Contacts(	(65)
& Housings(5)		

# Customers Also Bought



# Documents

### **CAD** Files

# 3D PDF

3D

Customer View Model ENG\_CVM\_CVM\_5-826634-0\_N.2d\_dxf.zip

English

PCB Mount Header, Right Angle, Board-to-Board, 100 Position, 2.54 mm [.1 in] Centerline, Breakaway, AMPMODU Headers



**Customer View Model** 

ENG\_CVM\_CVM\_5-826634-0\_N.3d\_igs.zip

English

Customer View Model

ENG\_CVM\_CVM\_5-826634-0\_N.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Environmental Compliance

Product Compliance

English

**Product Compliance** 

English

Agency Approvals

UL Report

English